

# NCE2025S

# NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE2025S uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

●V<sub>DS</sub> =20V,I<sub>D</sub> =25A

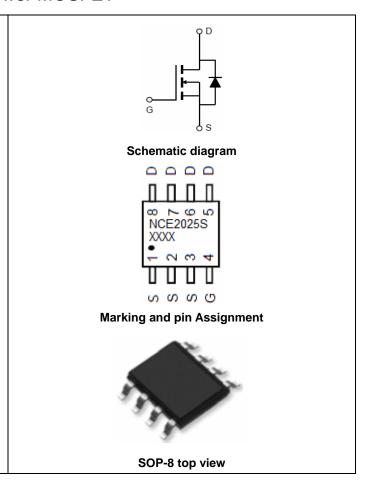
 $R_{DS(ON)} < 4m\Omega @ V_{GS} = 4.5V$ 

 $R_{DS(ON)} < 6m\Omega$  @  $V_{GS}$ =2.5V

- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current

### **Application**

- DC/DC Converter
- Battery protection



**Package Marking and Ordering Information** 

| Device Marking | Device   | Device Package | Reel Size | Tape width | Quantity   |
|----------------|----------|----------------|-----------|------------|------------|
| NCE2025S       | NCE2025S | SOP-8          | Ø330mm    | 12mm       | 2500 units |

Absolute Maximum Ratings (T<sub>4</sub>=25 °C unless otherwise noted)

| About the Maximum Ratings (TA-20 Sumose Striet Miss Hotsul) |                       |            |      |  |  |
|---|-----------------------|------------|------|--|--|
| Parameter   | Symbol                | Limit      | Unit |  |  |
| Drain-Source Voltage  | V <sub>DS</sub>       | 20         | V    |  |  |
| Gate-Source Voltage   | V <sub>G</sub> s      | ±12        | V    |  |  |
| Drain Current-Continuous                                    | I <sub>D</sub>        | 25         | А    |  |  |
| Drain Current-Continuous(T <sub>A</sub> =100 °C)            | I <sub>D</sub> (100℃) | 17.7       | А    |  |  |
| Pulsed Drain Current  | I <sub>DM</sub>       | 140        | А    |  |  |
| Maximum Power Dissipation                                   | P <sub>D</sub>        | 2.5        | W    |  |  |
| Operating Junction and Storage Temperature Range            | $T_{J}, T_{STG}$      | -55 To 150 | °C   |  |  |

#### **Thermal Characteristic**

| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 50 | °C/W |
|--|-----------------|----|------|
|--|-----------------|----|------|



# **NCE2025S**

Electrical Characteristics (T<sub>A</sub>=25 ℃ unless otherwise noted)

| Parameter                                  | Symbol              | Condition   | Min | Тур  | Max  | Unit  |  |
|--|---------------------|---|-----|------|------|-------|--|
| Off Characteristics                        |                     |   |     |      |      |       |  |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA 20                    |     | -    | -    | V     |  |
| Zero Gate Voltage Drain Current            | I <sub>DSS</sub>    | V <sub>DS</sub> =20V,V <sub>GS</sub> =0V                        | -   | -    | 1    | μA    |  |
| Gate-Body Leakage Current I <sub>GSS</sub> |                     | V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V                       | -   | -    | ±100 | nA    |  |
| On Characteristics (Note 3)                |                     |   |     |      |      |       |  |
| Gate Threshold Voltage                     | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA         | 0.5 | 0.75 | 1.2  | V     |  |
| Drain-Source On-State Resistance           | Б                   | $V_{GS}$ =4.5V, $I_D$ =20A                                      | -   | 3.5  | 4    | mΩ    |  |
| Diam-Source On-State Resistance            | $R_{DS(ON)}$        | V <sub>GS</sub> =2.5V, I <sub>D</sub> =18A                      |     | 4.2  | 6    | 11152 |  |
| Forward Transconductance                   | <b>g</b> FS         | V <sub>DS</sub> =5V,I <sub>D</sub> =20A                         | 60  | -    | -    | S     |  |
| Dynamic Characteristics (Note4)            |                     |   | •   |      |      |       |  |
| Input Capacitance                          | C <sub>lss</sub>    | V <sub>DS</sub> =10V,V <sub>GS</sub> =0V,                       | -   | 5300 | -    | PF    |  |
| Output Capacitance                         | C <sub>oss</sub>    | F=1.0MHz  | -   | 785  | -    | PF    |  |
| Reverse Transfer Capacitance               | C <sub>rss</sub>    | 1 - 1.0WH2  | -   | 629  | -    | PF    |  |
| Switching Characteristics (Note 4)         |                     |   |     |      |      |       |  |
| Turn-on Delay Time                         | t <sub>d(on)</sub>  |   | -   | 10   | -    | nS    |  |
| Turn-on Rise Time                          | t <sub>r</sub>      | $V_{DD}$ =10V, $R_L$ =0.5 $\Omega$                              | -   | 12   | -    | nS    |  |
| Turn-Off Delay Time                        | $t_{d(off)}$        | $V_{GS}$ =4. 5V, $R_{GEN}$ =3 $\Omega$                          | -   | 50   | -    | nS    |  |
| Turn-Off Fall Time                         | t <sub>f</sub>      |   | -   | 20   | -    | nS    |  |
| Total Gate Charge                          | Qg                  | V <sub>DS</sub> =10V,I <sub>D</sub> =20A,                       | -   | 64.9 | -    | nC    |  |
| Gate-Source Charge                         | Q <sub>gs</sub>     | V <sub>DS</sub> -10V,I <sub>D</sub> -20A, V <sub>GS</sub> =4.5V | -   | 6.5  | -    | nC    |  |
| Gate-Drain Charge                          | $Q_{gd}$            | V GS-4.5 V  | -   | 13.8 | -    | nC    |  |
| Drain-Source Diode Characteristics         |                     |   |     |      |      |       |  |
| Diode Forward Voltage (Note 3)             | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =25A                         | -   | -    | 1.2  | V     |  |
| Diode Forward Current (Note 2)             | Is                  |   | -   | -    | 25   | Α     |  |

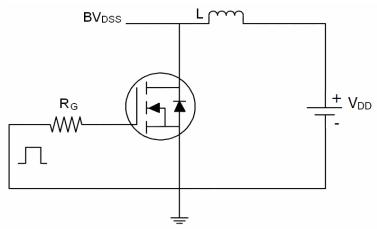
#### Notes:

- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

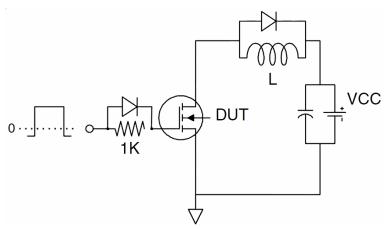
# NCE2025S

# **Test Circuit**

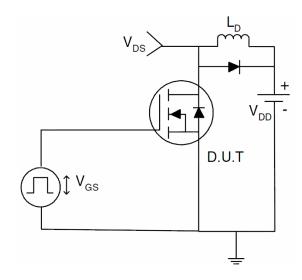
# 1) E<sub>AS</sub> Test Circuits



## 2) Gate Charge Test Circuit



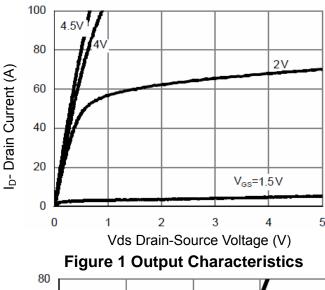
### 3) Switch Time Test Circuit

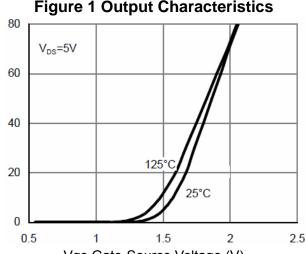


**Pb Free Product** 

# **NCE2025S**

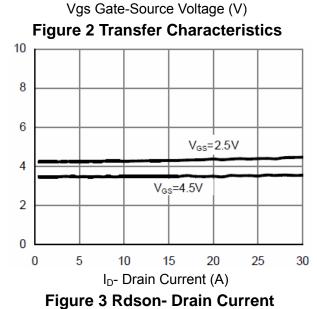
## **Typical Electrical and Thermal Characteristics (Curves)**

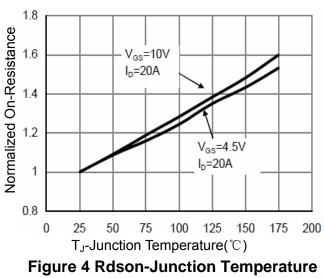


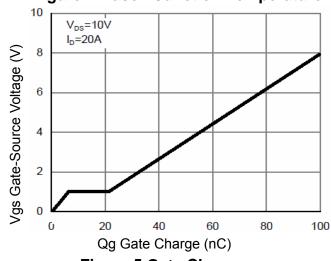


Ip- Drain Current (A)

Resistance(Ω)







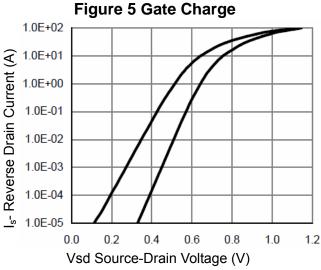


Figure 6 Source- Drain Diode Forward



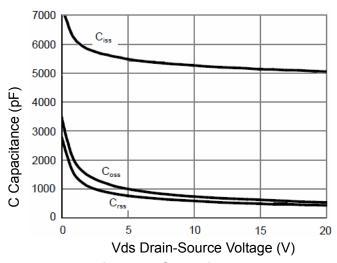


Figure 7 Capacitance vs Vds

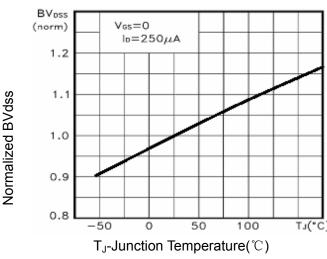
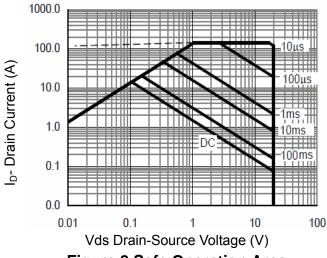
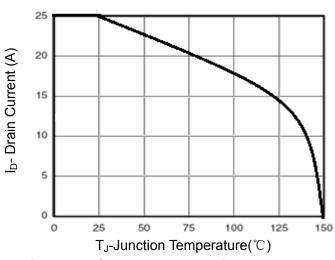


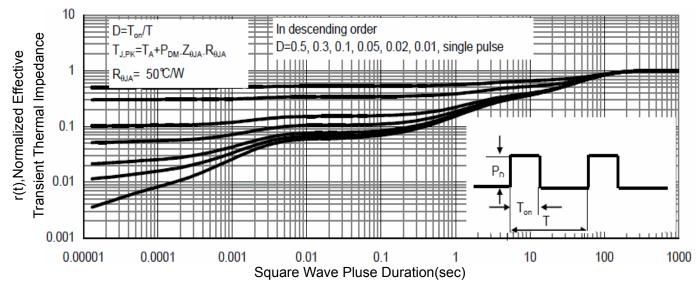
Figure 9 BV<sub>DSS</sub> vs Junction Temperature



**Figure 8 Safe Operation Area** 



**Figure 10 Current vs Junction Temperature** 



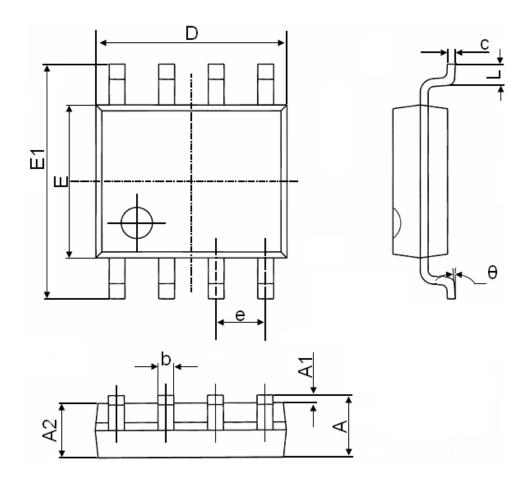
**Figure 11 Normalized Maximum Transient Thermal Impedance** 

**Pb Free Product** 



# NCE2025S

# **SOP-8 Package Information**



| Symbol | Dimensions I | n Millimeters | Dimensions In Inches |       |  |
|--------|--------------|---------------|----------------------|-------|--|
|        | Min.         | Max.          | Min.                 | Max.  |  |
| А      | 1.350        | 1.750         | 0.053                | 0.069 |  |
| A1     | 0.100        | 0.250         | 0.004                | 0.010 |  |
| A2     | 1.350        | 1.550         | 0.053                | 0.061 |  |
| b      | 0.330        | 0.510         | 0.013                | 0.020 |  |
| С      | 0.170        | 0.250         | 0.006                | 0.010 |  |
| D      | 4.700        | 5.100         | 0.185                | 0.200 |  |
| E      | 3.800        | 4.000         | 0.150                | 0.157 |  |
| E1     | 5.800        | 6.200         | 0.228                | 0.244 |  |
| е      | 1.270        | 1.270(BSC)    |                      | (BSC) |  |
| L      | 0.400        | 1.270         | 0.016                | 0.050 |  |
| θ      | 0°           | 8°            | 0°                   | 8°    |  |



#### http://www.ncepower.com

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